

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors	Ref #
1	BRS	14	(wafer or substrate) with hollow near cap and (singulat\$4 or saw\$4 or divid\$4 or dic\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/04 02:33				S3
2	BRS	42	(wafer or substrate) with hollow near cap	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/04 01:55				S2
3	BRS	102	(wafer or substrate) and hollow near cap and (singulat\$4 or saw\$4 or divid\$4 or dic\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/04 02:00				S4
4	BRS	42	(wafer or substrate) with hollow near (seal\$4 or cap) and (singulat\$4 or saw\$4 or divid\$4 or dic\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/04 02:08				S6
5	BRS	4	("5866942" "5956574" "5976912").PN. OR ("6521482").URPN.	US-PGPUB; USPAT; USOCR	2005/04/04 02:20				S7
6	BRS	50	("5976912").URPN.	USPAT	2005/04/04 02:22				S8

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors	Ref #
7	BRS	1	(wafer or substrate) with hollow near encapsulat\$4 and (singulat\$4 or saw\$4 or divid\$4 or dic\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/04 02:33				S9
8	BRS	18	(wafer or substrate) with hollow near cap\$4 and (singulat\$4 or saw\$4 or divid\$4 or dic\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/04 02:34				S10
9	BRS	228	(wafer or substrate) with (hollow or seal\$4) near cap and (singulat\$4 or saw\$4 or divid\$4 or dic\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/04 02:34				S5